IPC ASSOCIATION CONNEC	Material Comp © Copyright 2005. I international and Pa	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with low level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typhttp://www.ipc.org/IPC-175x Distribute				Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater						erials and M	ials and Mfg Information				
Supplier Info	rmation																
Company name* Company unio				unique ID			Unique ID Authority					Respon	Response Date*				
onsemi													2024-04-25				
Contact Name			Title - Conta	Title - Contact			Phone - Contact*					Email -	Email - Contact*				
Product-Env-Ste	wards	Product Enviro Compliance				NA NA					Produc	Product-Env-Stewards@onsemi.com					
Authorized Repre	esentative*	Title - Repre	Title - Representative			Phone - Representative*					Email -	Email - Representative*					
Product-Env-Ste	wards	Product Enviro Compliance				NA					Produc	Product-Env-Stewards@onsemi.com					
Reque	ster Item Number	ter Item Number Mfr Item Num FIN1215MTD		Mfr Item Name			Effective Da	ate V	Version M		Manufacturing Site		Weigh	nt*	UOM	Unit Type	
				LVDS 21-bit SerDes			2024-04-25 PH4			191.762		62	mg	Each			
Manufacturin	g Proccess Informa	ntion															
Termin	l Plating / Grid Array Material		Terminal Base Alloy J		J-STD-020 M	-020 MSL Rating		Peak Process Body Temperature		ture M	re Max Time at Peak Temper		ture Number of Reflow Cycles		eles		
Precious metal (e.g. Ag,Au, NiPdAu) (no Sn)			CU Alloy 2		2		260		С	30 seco		secor	nds	3			
Comments																	
ATTENTION: M	SL 2 Rated item require	es Dry Pack (	after electrica	l test)													
or more informa	ntion regarding material	composition	please refer to	page 3													

RoHS Material Composition Declaration			Declaration Type *	Detail	led						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU  RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on informationprovided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substa	ances per the definition above	Supplier Ac	ceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructional Complete all of the required	fields on all neggs of this form. Calcut th		a duan dawn. This will display the signature on	a Digitally sign	the declaration (if recurined by the						
Instructions: Complete all of the required Requester) and click on Submit Form to			e drop-down. This will display the signature ar	ea. Digitally sign	the declaration (if required by the						

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

<b>Homogeneous Material</b>	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure	
Die	2.3	mg	Supplier	Silicon (Si)	7440-21-3		2.3	mg	
Die Attach	0.272	mg	Supplier	Ethylene glycol dicyclopentenyl ether methacrylate	68586-19-6		0.0095	mg	
			Supplier	Bis(a,a-dimethylbenzyl) Peroxide	80-43-3		0.0018	mg	
			Supplier	Silver (Ag)	7440-22-4		0.2607	mg	
Lead Frame	70.195	mg	Supplier	Zinc (Zn)	7440-66-6		0.0842	mg	
			Supplier	Iron (Fe)	7439-89-6		1.6496	mg	
			Supplier	Copper (Cu)	7440-50-8		68.4401	mg	
			Supplier	Phosphorus (P)	7723-14-0		0.0211	mg	
Mold Compound-Black	111.1	mg		Epoxy resin	proprietary data		11.11	mg	
			Supplier	Phenol Resin	Proprietary Data		5.2217	mg	
			Supplier	Carbon Black (C)	1333-86-4		0.3333	mg	
			Supplier	Fused Silica (SiO2)	60676-86-0		94.435	mg	
Plating	6.705	mg	Supplier	Palladium (Pd)	7440-05-3		0.2286	mg	
			В	Nickel (Ni)	7440-02-0		6.3999	mg	
			Supplier	Gold (Au)	7440-57-5		0.0764	mg	
Wire Bond - Au	1.19	mg	Supplier	Gold (Au)	7440-57-5		1.19	mg	